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Vishay Siliconix

N-Channel 150 V (D-S) MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	150			
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0345			
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$	0.0410			
Q _g typ. (nC)	11			
I _D (A)	29			
Configuration	Single			

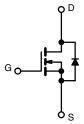
FEATURES

- ThunderFET® technology optimizes balance of R_{DS(on)}, Q_g, Q_{sw} and Q_{oss}
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- · Fixed telecom
- DC/DC converter
- Primary and secondary side switch
- · Battery management
- Synchronous rectification



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR632DP-T1-RE3

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	ınless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	150	V	
Gate-source voltage		V_{GS}	± 20	v	
	T _C = 25 °C		29		
Continuous drain surrent (T. 150 °C)	T _C = 70 °C		23		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	7.7 b, c		
	T _A = 70 °C		6.2 ^{b, c}	Δ.	
Pulsed drain current (t = 100 μs)		I _{DM}	50	A	
Continuous source-drain diode current	T _C = 25 °C	_	29		
Continuous source-drain diode current	T _A = 25 °C	l _S	4.5 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	25		
Single pulse avalanche energy	L = 0.1 IIII	E _{AS}	31.2	mJ	
	T _C = 25 °C		69.5		
Maying manyar discination	T _C = 70 °C 44.5	w			
Maximum power dissipation	T _A = 25 °C	P _D	5 ^{b, c}	VV	
	T _A = 70 °C	ı	3.2 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) c		_	260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	20	25	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.4	1.8	C/VV	

Notes

- Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- 6. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.
- g. $T_C = 25$ °C.



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	129	-	\//00	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6.1	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	100	nA	
Zoro goto voltago drain gurrant		V _{DS} = 150 V, V _{GS} = 0 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V, T _J = 70 °C	-	-	15	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30	=	-	Α	
Drain actives an etata registance a	В	V _{GS} =10 V, I _D = 10 A	-	0.0285	0.0345		
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0315	0.0410	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A	-	18	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	740	-		
Output capacitance	C _{oss}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	145	-	рF	
Reverse transfer capacitance	C _{rss}		-	8.5	-	- P'	
Total gata abaysa	0	V _{DS} = 75 V, V _{GS} = 10 V, I _D = 10 A	-	14	21		
Total gate charge	Q_g		-	11	17		
Gate-source charge	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	3.7	-	nC	
Gate-drain charge	Q_{gd}		-	3.9	-		
Output charge	Q _{oss}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$	-	34	-		
Gate resistance	R_g	f = 1 MHz	0.3	1.2	2	Ω	
Turn-on delay time	t _{d(on)}		-	8	16		
Rise time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_L = 7.5 \Omega, \text{ I}_D \cong 10 \text{ A},$	-	20	40		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	10	20		
Fall time	t _f		-	23	46		
Turn-on delay time	t _{d(on)}		-	9	18	ns	
Rise time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_L = 7.5 \Omega, \text{ I}_D \cong 10 \text{ A},$	-	27	54		
Turn-off delay time	t _{d(off)}	$V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	9	18		
Fall time	t _f		-	21	42		
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	29	Λ	
Pulse diode forward current	I _{SM}		-	-	50	A	
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.79	1.1	V	
Body diode reverse recovery time	t _{rr}		-	96.5	190	ns	
Body diode reverse recovery charge	Q _{rr}	1 10 A 41/44 100 A/ - T 05 20	-	270	540	nC	
Reverse recovery fall time	ta	$I_{\rm F} = 10 \text{A}, \text{dI/dt} = 100 \text{A/µs}, I_{\rm A} = 25 ^{\circ}\text{C}$		-			
Reverse recovery rise time	t _b		-	5.5	-	ns	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



0.1000

On-Resistance (Ω) 0090.0 0090.0 0090.0

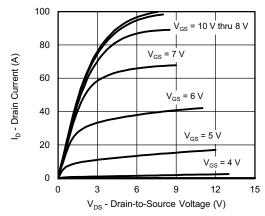
ထို 0.0200

0.0000

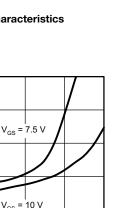
0

20

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics



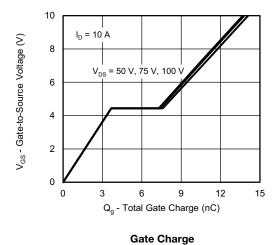
80

100

On-Resistance vs. Drain Current and Gate Voltage

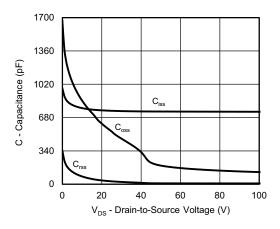
40 I_D - Drain Current (A)

60

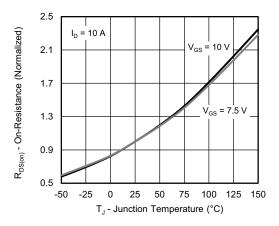


60 48 I_D - Drain Current (A) 36 24 T_C = 25 °C 12 = -55 °C T_C = 125 °C 0 0 2 10 V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



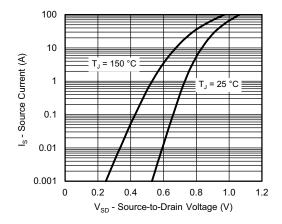
Capacitance



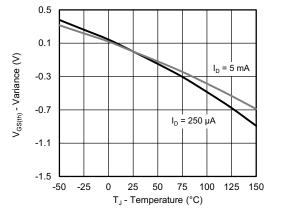
On-Resistance vs. Junction Temperature



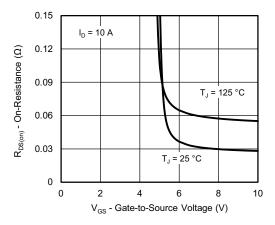
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



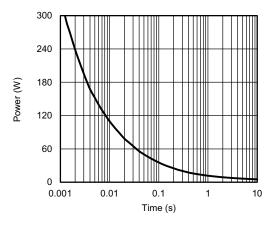
Source-Drain Diode Forward Voltage



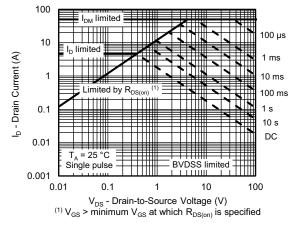
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

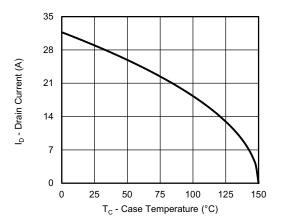


Single Pulse Power, Junction-to-Ambient

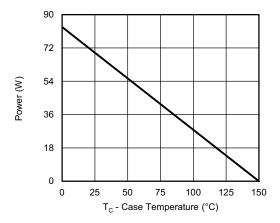


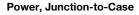
Safe Operating Area, Junction-to-Ambient

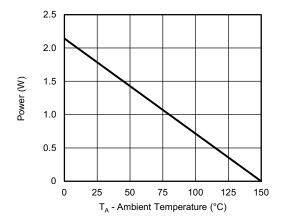
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a







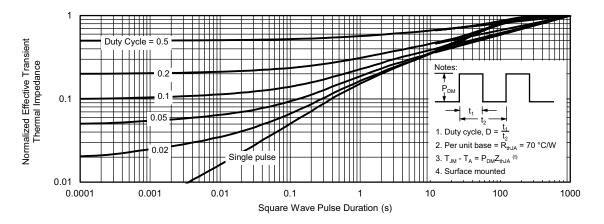
Power, Junction-to-Ambient

Note

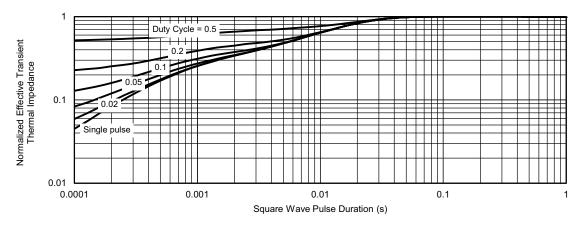
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74886.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)

Notes 1. Inch will govern. 2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

Backside View of Dual Pad

DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	_	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.		0.0225 typ.			
D5		3.98 typ.			0.157 typ.		
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.			0.030 typ.		
е		1.27 BSC		0.050 BSC			
K		1.27 typ.		0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.			0.005 typ.		

Revison: 13-Feb-17 1 Document Number: 71655



RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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